# SPIDER - TLE7230G SPI Driver for Enhanced Relay Control

Eight Channel Low-Side Switch

**Automotive Power** 





| ıa  | ole of C       | contents                                  | Page |
|-----|----------------|---|------|
| Pro | oduct S        | Summary                                   | 3    |
| 1 ( | Overvie        | w   | 5    |
|     |                | ck Diagram                                |      |
|     |                | ms  |      |
|     |                |   |      |
|     |                | figuration                                |      |
|     |                | Assignment SPIDER - TLE7230G              |      |
| 2   | 2.2 Pin        | Definitions and Functions                 | /    |
| 3 E | Electric       | al Characteristics                        | 9    |
|     |                | rimum Ratings                             |      |
|     |                | · ·                                       |      |
|     |                | escription and Electrical Characteristics |      |
| 4   |                | ver Stages                                |      |
|     |                | Power Supply                              |      |
|     | 4.1.2<br>4.1.3 | Input Circuit                             |      |
|     | 4.1.3          | Inductive Output Clamp                    |      |
|     | 4.1.4          | Electrical Characteristics                |      |
|     | 4.1.6          |   |      |
| /   |                | tection Functions                         |      |
| -   |                | Over Load Protection                      |      |
|     |                | Over Temperature Protection               |      |
|     | 4.2.3          | Reverse Polarity Protection               |      |
|     | 4.2.4          | Electrical Characteristics                |      |
|     | 4.2.5          | Command Description                       |      |
| 4   |                | gnostic Features                          |      |
|     | 4.3.1          |   |      |
|     |                | Command Description                       |      |
| 4   |                | al Peripheral Interface (SPI)             |      |
|     | 4.4.1          |   |      |
|     | 4.4.2          | Daisy Chain Capability                    |      |
|     | 4.4.3          | Timing Diagrams                           |      |
|     | 4.4.4          | Electrical Characteristics                |      |
|     | 4.4.5          | SPI Protocol                              | 30   |
|     | 4.4.6          | Register Overview                         | 32   |
| 5 F | Package        | e Outlines                                | 33   |
|     | _              | n History                                 |      |



#### **SPI Driver for Enhanced Relay Control**

#### SPIDER - TLE7230G





The SPIDER - TLE7230G is an eight channel low-side power switch in PG-DSO-24-13 package providing embedded protective functions. It is especially designed for standard relays in automotive applications.

A serial peripheral interface (SPI) is utilized for control and diagnosis of the device and the load. For direct control, there is an input pin available.

The power transistors are built by N-channel vertical power MOSFETs. The device is monolithically integrated in Smart Power Technology.



PG-DSO-24-13

#### **Product Summary**

| Supply voltage                              | $V_{dd}$                  | 4.5 5.5 V |
|---|---------------------------|-----------|
| Supply voltage for SO buffer                | $V_{\sf VSO}$             | 3.0 5.5 V |
| On-State resistance at 25 °C                | R <sub>DS(ON, max)</sub>  | 1.0 Ω     |
| Nominal load current                        | $I_{L(nom,\;max)}$        | 300 mA    |
| Over load current limitation                | I <sub>DS(LIM, min)</sub> | 1 A       |
| Output leakage current per channel at 25 °C | I <sub>DS(OFF, max)</sub> | 1 μΑ      |
| Drain to source clamping voltage            | $V_{\mathrm{DS(CL,min)}}$ | 48 V      |
| SPI clock frequency                         | $f_{ m SCLK(max)}$        | 5 MHz     |

| Туре              | Ordering Code | Package      |
|-------------------|---------------|--------------|
| SPIDER - TLE7230G | on request    | PG-DSO-24-13 |



#### **Basic Features**

- · 16 bit SPI for diagnostics and control
- · SPI providing daisy chain capability
- 3.3 V and 5 V compatible SPI
- A configurable input pin offers complete flexibility for PWM operation
- · Stable behavior at under voltage
- Green Product (RoHS compliant)
- AEC Qualified

#### **Protective Functions**

- · Short circuit protection
- · Over load protection, configurable behavior (limitation or shutdown)
- Thermal shutdown, configurable behavior (latch or restart)
- Electrostatic discharge protection (ESD)

#### **Diagnostic Functions**

- · Diagnostic information via SPI
- · Open load detection in OFF-state
- · Shorted to GND detection in OFF-state
- · Over temperature in ON-state
- · Over load in ON-state

#### **Applications**

- Especially designed for driving relays in automotive applications
- · All types of capacitive, resistive and inductive loads

Data Sheet 4 V1.1, 2008-02-19

Overview

#### 1 Overview

The SPIDER - TLE7230G is an eight channel low-side relay switch (1.0  $\Omega$  per channel) in PG-DSO-24-13 package providing embedded protective functions. The 16 bit serial peripheral interface (SPI) is utilized for control and diagnosis of the device and the loads. The SPI interface provides daisy-chain capability in order to assemble multiple devices in one SPI chain by using the same number of micro-controller pins.

The SPIDER - TLE7230G is equipped with one input pin that can be individually routed to the output control of each channel thus offering complete flexibility in design and PCB-layout. The input mapping as well as the boolean operation between input signal an output control signal is configured via SPI.

The device provides full diagnosis of the load, which is open load, short to GND as well as short circuit to  $V_{\rm bat}$  detection and over load / over temperature indication. The SPI diagnosis flags indicate latched fault conditions that may have occurred.

Each output stage is protected against short circuit. In case of over load, the current of the affected channel is limited. There is a temperature sensor available for each channel to protect the device in case of over temperature. The shut down behavior in case of over load or over temperature can be configured via SPI for each channel individually.

#### 1.1 Block Diagram

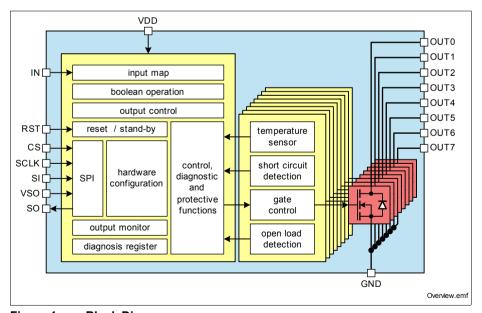


Figure 1 Block Diagram

Overview

#### 1.2 Terms

Following figure shows all terms used in this data sheet.

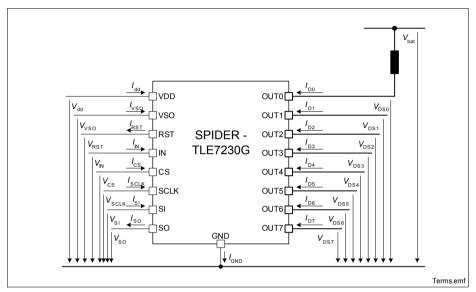


Figure 2 Terms

In all tables of electrical characteristics is valid: Channel related symbols without channel number are valid for each channel separately (e.g.  $V_{\rm DS}$  specification is valid for  $V_{\rm DS0}$  ...  $V_{\rm DS7}$ ).

All SPI register bits are marked as follows: ADDR. PARAMETER (e.g. CTL.OUT0). In SPI register description, the values in bold letters (e.g. 0) are default values.

**Pin Configuration** 

# 2 Pin Configuration

# 2.1 Pin Assignment SPIDER - TLE7230G

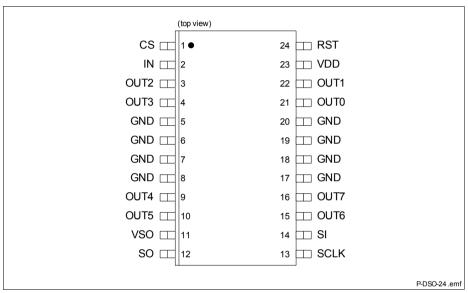


Figure 3 Pin Configuration PG-DSO-24-13

#### 2.2 Pin Definitions and Functions

| Pin                              | Symbol | I/O | Function                            |  |  |  |
|----------------------------------|--------|-----|-------------------------------------|--|--|--|
| Power Su                         | pply   |     |                                     |  |  |  |
| 23                               | VDD    | -   | Power supply                        |  |  |  |
| 11                               | VSO    | -   | Power supply for SO buffer          |  |  |  |
| 5, 6, 7, 8,<br>17, 18,<br>19, 20 | GND    | -   | Ground                              |  |  |  |
| Power Sta                        | iges   |     |                                     |  |  |  |
| 21                               | OUT0   | 0   | Drain of power transistor channel 0 |  |  |  |
| 22                               | OUT1   | 0   | Drain of power transistor channel 1 |  |  |  |
| 3                                | OUT2   | 0   | Drain of power transistor channel 2 |  |  |  |



# **Pin Configuration**

| Pin    | Symbol | I/O | Function                            |  |  |  |
|--------|--------|-----|-------------------------------------|--|--|--|
| 4      | OUT3   | 0   | Drain of power transistor channel 3 |  |  |  |
| 9      | OUT4   | 0   | Drain of power transistor channel 4 |  |  |  |
| 10     | OUT5   | 0   | Drain of power transistor channel 5 |  |  |  |
| 15     | OUT6   | 0   | Drain of power transistor channel 6 |  |  |  |
| 16     | OUT7   | 0   | Drain of power transistor channel 7 |  |  |  |
| Inputs |        | 1   |                                     |  |  |  |
| 24     | RST    | I   | Reset input pin (active low)        |  |  |  |
| 2      | IN     | I   | Input multiplexer input pin         |  |  |  |
| SPI    |        | 1   |                                     |  |  |  |
| 1      | CS     | I   | SPI Chip select (active low)        |  |  |  |
| 13     | SCLK   | I   | Serial clock                        |  |  |  |
| 14     | SI     | I   | Serial data in                      |  |  |  |
| 12     | SO     | 0   | Serial data out                     |  |  |  |

**Electrical Characteristics** 

# 3 Electrical Characteristics

# 3.1 Maximum Ratings

Stresses above the ones listed here may affect device reliability or may cause permanent damage to the device.

Unless otherwise specified:  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm i}$  = -40 °C to 150 °C

| Pos.    | Parameter   | Symbol        | Limit | Values             | Unit |   |  |
|---------|---|---------------|-------|--------------------|------|---|--|
|         |   |               | min.  | max.               |      | Conditions  |  |
| Power   | Supply  | 1             |       | П                  |      | 1.  |  |
| 3.1.1   | Power supply voltage  | $V_{dd}$      | -0.3  | 5.5                | V    |   |  |
| 3.1.2   | VSO supply voltage  | $V_{\sf VSO}$ | -0.3  | $V_{\rm dd}$ + 0.3 | V    | 1)  |  |
| 3.1.3   | Power supply voltage for full short circuit protection (single pulse) | $V_{bat(SC)}$ | 0     | 20<br>28           | V    | OVL = 0 <sup>2)</sup><br>OVL = 1                                |  |
| Power   | Stages  |               |       |                    |      |   |  |
| 3.1.4   | Load current  | $I_{D}$       | -1    | 1                  | Α    |   |  |
| 3.1.5   | Voltage at power transistor   | $V_{DS}$      |       | 48                 | V    |   |  |
| 3.1.6   | Maximum energy dissipation one channel single pulse                   | $E_{AS}$      |       |                    | mJ   | 3)  |  |
|         |   |               |       | 65                 |      | $T_{j(0)}$ = 85 °C<br>$I_{D(0)}$ = 0.4 A<br>$T_{j(0)}$ = 150 °C |  |
|         |   | -             |       | 50                 |      | $I_{D(0)}^{(1)} = 0.3 \text{ A}$                                |  |
|         | Maximum energy dissipation one channel repetitive pulses              | $E_{AR}$      |       |                    | mJ   | $T_{\rm j(0)} = 150  ^{\circ}{\rm C}$                           |  |
|         | 1 · 10 <sup>4</sup> cycles  |               |       | 20                 |      | $I_{\rm D(0)}$ = 0.25 A   |  |
|         | 1 · 10 <sup>6</sup> cycles  |               |       | 16                 |      | $I_{D(0)}$ = 0.2 A  |  |
| Logic F | Pins  | •             |       | •                  | •    |   |  |
| 3.1.7   | Voltage at input pin  | $V_{IN}$      | -0.3  | 5.5                | V    |   |  |
| 3.1.8   | Voltage at reset pin  | $V_{RST}$     | -0.3  | 5.5                | V    |   |  |
| 3.1.9   | Voltage at chip select pin  | $V_{CS}$      | -0.3  | 5.5                | V    |   |  |
| 3.1.10  | Voltage at serial clock pin   | $V_{SCLK}$    | -0.3  | 5.5                | V    |   |  |



#### **Electrical Characteristics**

Unless otherwise specified:  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm i}$  = -40 °C to 150 °C

| Pos.   | Parameter                                    | Symbol            | Limit ' | Values | Unit | Test                                  |
|--------|--|-------------------|---------|--------|------|---------------------------------------|
|        |  |                   | min.    | max.   |      | Conditions                            |
| 3.1.11 | Voltage at serial input pin                  | $V_{SI}$          | -0.3    | 5.5    | V    |                                       |
| 3.1.12 | Voltage at serial output pin                 | $V_{SO}$          | -0.3    | 5.5    | V    |                                       |
| Tempe  | ratures                                      |                   |         |        |      | -                                     |
| 3.1.13 | Junction Temperature                         | $T_{j}$           | -40     | 150    | °C   |                                       |
| 3.1.14 | Dynamic temperature increase while switching | $\Delta T_{ m j}$ |         | 60     | °C   |                                       |
| 3.1.15 | Storage Temperature                          | $T_{stg}$         | -55     | 150    | °C   |                                       |
| ESD St | sceptibility                                 |                   |         |        | '    | 1                                     |
| 3.1.16 | ESD susceptibility HBM                       | $V_{ESD}$         | -2      | 2      | kV   | according to<br>EIA/JESD<br>22-A 114B |

<sup>1)</sup>  $V_{dd} + 0.3 \text{ V} < 5.5 \text{ V}$ 

<sup>2)</sup> Details on configuration of protective function OLCR.OVL can be found in Section 4.2.5

<sup>3)</sup> Pulse shape represents inductive switch off:  $I_{\rm D}(t)$  =  $I_{\rm D}(0)$  × (1 - t /  $t_{\rm pulse}$ ); 0 < t <  $t_{\rm pulse}$ 



**Block Description and Electrical Characteristics** 

# 4 Block Description and Electrical Characteristics

#### 4.1 Power Stages

The SPIDER - TLE7230G is an eight channel low-side relay switch. The power stages are built by N-channel vertical power MOSFET transistors.

#### 4.1.1 Power Supply

The SPIDER - TLE7230G is supplied by power supply line  $V_{\rm dd}$  which is used for the digital as well as the analog functions of the device including the gate control of the power stages. There is a power-on reset function implemented for the supply line. After start-up of the power supply, all SPI registers are reset to their default values. A capacitor at pins VDD to GND is recommended.

The voltage at pin VSO is used by the driver of the SO line at the SPI. It is designed to be functional at a wide voltage range.

There is a reset pin available. At low level at this pin, all registers are set to their default values and the quiescent supply current is minimized.

#### 4.1.2 Input Circuit

There is an input pin available at SPIDER - TLE7230G to control the output stages.

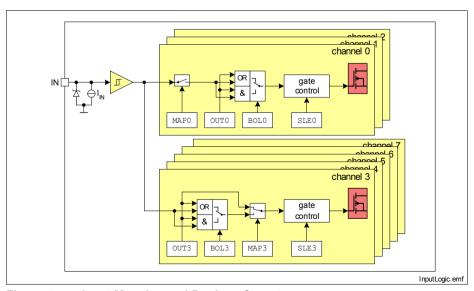


Figure 4 Input Mapping and Boolean Operator

Data Sheet 11 V1.1, 2008-02-19



#### **Block Description and Electrical Characteristics**

The input signal can be configured to be used as control signal of the output stages for each channel separately. The channels 0 to 3 differ from the channels 4 to 7 in the mapping behavior. Please refer to **Figure 4** for details.

The current sink to ground at the input pin ensures that the channels switch off in case of open pin. The zener diode protects the input circuit against ESD pulses.

#### 4.1.3 Inductive Output Clamp

When switching off inductive loads, the potential at pin OUT rises to  $V_{\rm DS(CL)}$  potential, because the inductance intends to continue driving the current. The voltage clamping is necessary to prevent destruction of the device, see **Figure 5** for details. Nevertheless, the maximum allowed load inductance is limited.

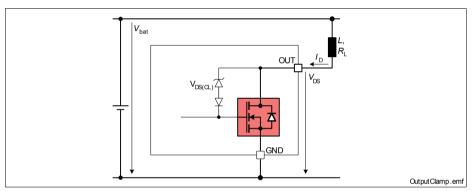


Figure 5 Output Clamp Implementation

#### Maximum Load Inductance

During demagnetization of inductive loads, energy has to be dissipated in the SPIDER - TLE7230G. This energy can be calculated with following equation:

$$E = V_{\rm DS(CL)} \cdot \left[ \frac{V_{\rm bat} - V_{\rm DS(CL)}}{R_{\rm L}} \cdot \ln \left( 1 - \frac{R_{\rm L} \cdot I_{\rm D}}{V_{\rm bat} - V_{\rm DS(CL)}} \right) + I_{\rm D} \right] \cdot \frac{L}{R_{\rm L}}$$
(1)

The equation simplifies under the assumption of  $R_L$  = 0:

$$E = \frac{1}{2}LI_{D}^{2} \cdot \left(1 - \frac{V_{\text{bat}}}{V_{\text{bat}} - V_{\text{DS(CL)}}}\right)$$
 (2)

The energy, which is converted into heat, is limited by the thermal design of the component.

Data Sheet 12 V1.1, 2008-02-19



#### **Block Description and Electrical Characteristics**

# 4.1.4 Timing Diagrams

The power transistors are switched on and off with a dedicated slope via the  $\mathtt{OUT}$  bits of the serial peripheral interface SPI. The switching times  $t_{\mathsf{ON}}$  and  $t_{\mathsf{OFF}}$  are designed equally.

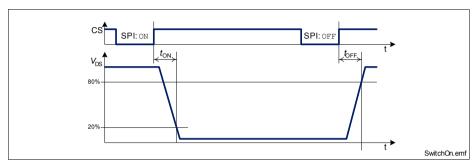


Figure 6 Switching a Resistive Load

When the input mapping is configured accordingly, a high signal at the input pin is equivalent to a SPI ON command.

Data Sheet 13 V1.1, 2008-02-19



# **Block Description and Electrical Characteristics**

#### 4.1.5 **Electrical Characteristics**

Unless otherwise specified:  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C typical values:  $V_{\rm dd}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.    | Parameter  | Symbol                          | Lin         | Limit Values |             |    | Test  |  |
|---------|--|---------------------------------|-------------|--------------|-------------|----|---|--|
|         | Power Supply   |                                 | min. typ. r |              | max.        |    | Conditions  |  |
| Power   | Supply   | 1                               | '           |              |             |    |   |  |
| 4.1.1   | Power supply voltage   | $V_{dd}$                        | 4.5         |              | 5.5         | V  |   |  |
| 4.1.2   | Power supply current   | $I_{\rm dd(ON)}$                |             | 3            | 5           | mA | all channels ON   |  |
| 4.1.3   | Power supply reset current                                     | $I_{\mathrm{dd}(\mathrm{RST})}$ |             |              | 10          | μА | $\begin{split} V_{\text{RST}} &= 0 \text{ V} \\ V_{\text{IN}} &= 0 \text{ V} \\ V_{\text{SCLK}} &= 0 \text{ V} \\ V_{\text{SI}} &= 0 \text{ V} \\ V_{\text{CS}} &= V_{\text{dd}} \end{split}$ |  |
| 4.1.4   | Power-on reset threshold voltage                               | $V_{\rm dd(PO)}$                |             |              | 4.5         | V  |   |  |
| Outpu   | t Characteristics  |                                 |             | •            | •           |    |   |  |
| 4.1.5   | On-State resistance per channel                                | $R_{DS(ON)}$                    |             | 0.8          | 1.0         | Ω  | $I_{\rm L}$ = 500 mA<br>$V_{\rm dd}$ = 5 V<br>$T_{\rm j}$ = 25 °C <sup>1)</sup><br>$T_{\rm i}$ = 150 °C   |  |
| 4.1.6   | Output leakage<br>current in stand-by<br>mode<br>(per channel) | $I_{D(RST)}$                    |             |              | 1<br>2<br>5 | μА | $V_{DS} = 13.5 \text{ V}$<br>$T_{j} = 25 \text{ °C}^{-1}$<br>$T_{j} = 125 \text{ °C}$<br>$T_{i} = 150 \text{ °C}^{-1}$  |  |
| 4.1.7   | Output clamping voltage  | $V_{\mathrm{DS(CL)}}$           | 48          |              | 60          | V  |   |  |
| Input ( | Characteristics  | 1                               | '           |              |             |    |   |  |
| 4.1.8   | L level of pin IN  | $V_{IN(L)}$                     | 0           |              | 1.0         | V  |   |  |
| 4.1.9   | H level of pin IN  | $V_{IN(H)}$                     | 2.0         |              | $V_{dd}$    | V  |   |  |
| 4.1.10  | Input voltage hysteresis at pin IN                             | $\Delta V_{IN}$                 |             | 0.1          |             | V  | 1)  |  |
| 4.1.11  | L-input pull-down current through pin IN                       | $I_{IN(L)}$                     | 10          |              | 100         | μА | 1) V <sub>IN</sub> = 1 V  |  |
| 4.1.12  | H-input pull-down current through pin IN                       | $I_{IN(H)}$                     | 20          | 50           | 100         | μА | <i>V</i> <sub>IN</sub> = 5 V  |  |

Data Sheet 14 V1.1, 2008-02-19



#### **Block Description and Electrical Characteristics**

Unless otherwise specified:  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm i}$  = -40 °C to 150 °C

typical values:  $V_{dd}$  = 5.0 V,  $T_{i}$  = 25 °C

| Pos.                                       | Parameter                                      | Symbol           | Limit Values |      |          | Unit | Test   |  |
|--|--|------------------|--------------|------|----------|------|--|--|
|  |  |                  | min.         | typ. | max.     |      | Conditions   |  |
| Reset                                      |  | 1                | '            |      |          |      |  |  |
| 4.1.13                                     | L level of pin RST                             | $V_{RST(L)}$     | 0            |      | 1        | V    |  |  |
| 4.1.14                                     | H level of pin RST                             | $V_{RST(H)}$     | 2            |      | $V_{dd}$ | V    |  |  |
| 4.1.15                                     | L-input pull-up current through pin RST        | $I_{RST(L)}$     | 0            |      | 10       | μА   | $V_{RST}$ = 1 V  |  |
| 4.1.16 H-input pull-up current through pin |  | $I_{RST(H)}$     | 20           | 50   | 100      | μА   | V <sub>RST</sub> = 2 V   |  |
| Therm                                      | al Resistance                                  |                  |              |      |          |      |  |  |
| 4.1.17                                     | Junction to ambient all channels active        | $R_{thja}$       |              | 75   |          | K/W  | 1) 2)  |  |
| Timing                                     | js   | 1                | '            |      |          |      |  |  |
| 4.1.18                                     | Power-on wake up time                          | $t_{\rm wu(PO)}$ |              |      | 200      | μS   |  |  |
| 4.1.19                                     | Reset duration                                 | $t_{RST(L)}$     | 10           |      |          | μS   |  |  |
| 4.1.20                                     | Turn-on time $V_{\rm DS}$ = 20% $V_{\rm bat}$  | t <sub>ON</sub>  |              |      | 15<br>60 | μS   | $V_{\rm bat}$ = 14 V $I_{\rm DS}$ = 500 mA resistive load SLE = 0 SLE = 1  |  |
| 4.1.21                                     | Turn-off time $V_{\rm DS}$ = 80% $V_{\rm bat}$ | t <sub>OFF</sub> |              |      | 15<br>60 | μS   | $\begin{split} V_{\rm bat} &= 14 \text{ V} \\ I_{\rm DS} &= 500 \text{ mA} \\ \text{resistive load} \\ \text{SLE} &= 0 \\ \text{SLE} &= 1 \end{split}$ |  |

<sup>1)</sup> Not subject to production test, specified by design

Note: Characteristics show the deviation of parameter at the given supply voltage and junction temperature. Typical values show the typical parameters expected from manufacturing.

Data Sheet 15 V1.1, 2008-02-19

Device mounted on PCB (100 mm x 100 mm x 1.5 mm). PCB without blown air. All channels with balanced loads.



# **Block Description and Electrical Characteristics**

# 4.1.6 Command Description

#### **IMCR**

# **Input Mapping Configuration Register**

| Reset Value: 08 <sub>H</sub> |
|------------------------------|
|------------------------------|

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |  |
|------|------|------|------|------|------|------|------|--|
| MAP7 | MAP6 | MAP5 | MAP4 | MAP3 | MAP2 | MAP1 | MAP0 |  |
| rw   |  |

| Field             | Bits | Туре | Description   |
|-------------------|------|------|---|
| MAPn<br>(n = 7-0) | n    | rw   | Input Mapping Configuration Channel n  Channel n can not be controlled with input pin.  (default value) |
|                   |      |      | Channel n can be controlled with input pin, depending on additional set-up.                             |

#### BOCR

# **Boolean Operator Configuration Register**

Reset Value: 00<sub>H</sub>

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |  |
|------|------|------|------|------|------|------|------|--|
| BOL7 | BOL6 | BOL5 | BOL4 | BOL3 | BOL2 | BOL1 | BOL0 |  |
| rw   |  |

| Field             | Bits | Type | Description   |
|-------------------|------|------|---|
| BOLn<br>(n = 7-0) | n    | rw   | Boolean Operator Configuration Channel n  Ucgic "OR" for channel n (default value).  Logic "AND" for channel n. |



# **Block Description and Electrical Characteristics**

#### SRCR

#### Slew Rate Configuration Register

| Reset | Valu | e: 00 <sub>H</sub> |
|-------|------|--------------------|
|-------|------|--------------------|

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| SLE7 | SLE6 | SLE5 | SLE4 | SLE3 | SLE2 | SLE1 | SLE0 |
| rw   |

| Field     | Bits | Type | Description                                   |
|-----------|------|------|---|
| SLEn      | n    | rw   | Slew Rate Configuration Channel n             |
| (n = 7-0) |      |      | O Channel n is switched fast (default value). |
|           |      |      | 1 Channel n is switched slowly.               |

# CTL Output Control Register

#### Reset Value: 00<sub>H</sub>

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| OUT7 | OUT6 | OUT5 | OUT4 | OUT3 | OUT2 | OUT1 | ОПТ0 |
| rw   |

| Field             | Bits | Type | Description   |
|-------------------|------|------|---|
| OUTn<br>(n = 7-0) | n    | rw   | Output Control Channel n  Channel n is switched off (default value).  Channel n is switched on, depending on additional set-up. |



**Protection Functions** 

#### 4.2 Protection Functions

The device provides embedded protective functions. Integrated protection functions are designed to prevent IC destruction under fault conditions described in this data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

There is an over load and over temperature protection implemented in the SPIDER - TLE7230G. The behavior of the protective functions can be set-up via SPI. Following figure gives an overview about the protective functions.

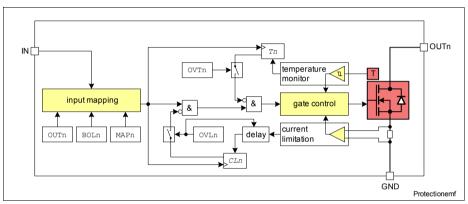


Figure 7 Protective Functions

#### 4.2.1 Over Load Protection

The SPIDER - TLE7230G is protected in case of over load or short circuit of the load. The behavior in case of over load can be configured as follows:

- a) The current is limited to  $I_{\text{DS(LIM)}}$ . After time  $t_{\text{d(fault)}}$ , the according over load flag Ln is set. The channel may shut down due to over temperature.
- b) The current is limited to  $I_{\text{DS(LIM)}}$ . After time  $t_{\text{d(off)}}$ , the over loaded channel n switches off and the according over load flag Ln is set.

The over load flag (CLn) of the affected channel is cleared by a low-high transition of the input signal. For timing information, please refer to **Figure 8** for details.



#### **Protection Functions**

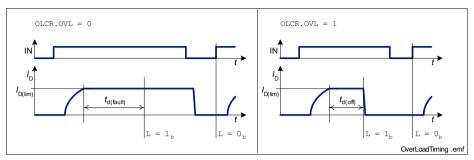


Figure 8 Over Load Behavior

#### 4.2.2 Over Temperature Protection

A temperature sensor for each channel causes an overheated channel n to switch off immediately to prevent destruction. The behavior in case of over temperature can be configured as follows:

- a) After cooling down, the channel is switched on again with thermal hysteresis  $\Delta T_i$ .
- b) The affected channel stays switched off until the over temperature flag is cleared.

The over temperature flag of the affected channel is cleared by a low-high transition of the input signal.

# 4.2.3 Reverse Polarity Protection

In case of reverse polarity, the intrinsic body diode of the power transistor causes power dissipation. The reverse current through the intrinsic body diode has to be limited by the connected load. The  $V_{\rm dd}$  supply pin must be protected against reverse polarity externally. The over-temperature protection as well as other protective functions are not active during reverse polarity.



#### **Protection Functions**

#### 4.2.4 **Electrical Characteristics**

Unless otherwise specified:  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C typical values:  $V_{\rm dd}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.  | Parameter                            | Symbol                 | Lin  | nit Val | ues  | Unit | Test       |  |
|-------|--------------------------------------|------------------------|------|---------|------|------|------------|--|
|       |                                      |                        | min. | typ.    | max. |      | Conditions |  |
| Over  | Load Protection                      |                        |      |         | •    |      |            |  |
| 4.2.1 | Over load current limitation         | $I_{D(lim)}$           | 1    |         | 2    | Α    | OAT = 0    |  |
| 4.2.2 | Over load shut-down delay time       | $t_{d(off)}$           | 10   |         | 50   | μS   | OVL = 1    |  |
| Over  | Temperature Protectio                | n                      |      | •       |      | •    |            |  |
| 4.2.3 | Over temperature shut-down threshold | $T_{\rm j(OT)}$        | 170  |         | 200  | °C   | 1)         |  |
| 4.2.4 | Thermal hysteresis                   | $\Delta T_{\rm j(OT)}$ |      | 10      |      | K    | 1)         |  |

<sup>1)</sup> Not subject to production test, specified by design



**Protection Functions** 

Reset Value: 00<sub>H</sub>

Reset Value: 00<sub>H</sub>

# 4.2.5 Command Description

#### **OLCR**

# **Over Load Configuration Register**

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| OVL7 | OVL6 | OVL5 | OVL4 | OVL3 | OVL2 | OVL1 | OVL0 |

| Field             | Bits | Type | Description   |
|-------------------|------|------|---|
| OVLn<br>(n = 7-0) | n    | rw   | Over Load Configuration Channel n  O Channel n limits the current in case of over load (default value).  Channel n shuts down in case of over load. |

#### **OTCR**

#### **Over Temperature Configuration Register**

| - | = | - | - |   |   |   |   | • |
|---|---|---|---|---|---|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |   |
|   |   |   |   |   |   |   |   |   |

| ,    | ·    |      | . 7  | J    |      | . '  | . 0  |  |
|------|------|------|------|------|------|------|------|--|
| OVT7 | OVT6 | OVT5 | OVT4 | OVT3 | OVT2 | OVT1 | OVT0 |  |
| rw   |  |

| Field             | Bits | Type | Description  |
|-------------------|------|------|--|
| OVTn<br>(n = 7-0) | n    | rw   | Over Temperature Configuration Channel n 0 Autorestart (default value) 1 Latched shut down |



**Diagnostic Features** 

#### 4.3 Diagnostic Features

The SPI of SPIDER - TLE7230G provides diagnosis information about the device and about the load. There are following diagnosis flags implemented:

- The diagnosis information of the protective functions (flags CLn and Tn) of channel n is latched in the diagnosis flag Pn.
- The open load diagnosis of channel n is latched in the diagnosis flag OLn.
- The short to gnd monitor information of channel n is latched in the diagnosis flag SGn.

All flags are cleared after a successful SPI transmission.

There is an output state monitor implemented in the device that indicates the switch state of the device in register STA. Depending on the voltage level at input pin and protective functions the bits are high or low.

Please see Figure 9 for details:

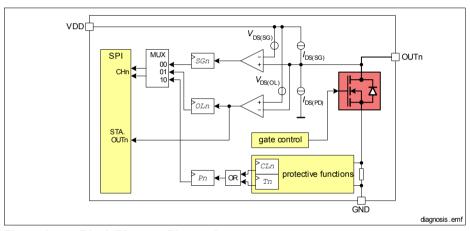


Figure 9 Block Diagram Diagnosis



**Diagnostic Features** 

#### 4.3.1 **Electrical Characteristics**

Unless otherwise specified:  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C typical values:  $V_{\rm dd}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.  | Parameter   | Symbol                | Lin                   | nit Val               | ues                   | Unit | <b>Test Conditions</b> |
|-------|---|-----------------------|-----------------------|-----------------------|-----------------------|------|------------------------|
|       |   |                       | min.                  | typ.                  | max.                  |      |                        |
| OFF S | State Diagnosis                                       | 1                     |                       |                       |                       |      |                        |
| 4.3.1 | Open load detection threshold voltage                 | $V_{\mathrm{DS(OL)}}$ | V <sub>dd</sub> - 2.5 | V <sub>dd</sub> - 2   | V <sub>dd</sub> - 1.3 | V    |                        |
| 4.3.2 | Output pull-down diagnosis current per channel        | $I_{D(PD)}$           | 50                    | 90                    | 150                   | μА   |                        |
| 4.3.3 | Short to gnd detection threshold voltage              | $V_{\mathrm{DS(SG)}}$ | V <sub>dd</sub> - 3.4 | V <sub>dd</sub> - 3.0 | V <sub>dd</sub> - 2.6 | V    |                        |
| 4.3.4 | Output diagnosis current for short to gnd per channel | $I_{D(SG)}$           | -150                  | -100                  | -50                   | μΑ   | $V_{\rm DS}$ = 0 V     |
| 4.3.5 | Fault delay time                                      | $t_{\rm d(fault)}$    | 50                    | 100                   | 200                   | μS   |                        |



**Diagnostic Features** 

# 4.3.2 Command Description

#### STA Output Status Monitor

Reset Value: 00<sub>H</sub>

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |   |
|------|------|------|------|------|------|------|------|---|
| OUT7 | OUT6 | OUT5 | OUT4 | OUT3 | OUT2 | OUT1 | OUT0 | l |
| r    | r    | r    | r    | r    | r    | r    | r    |   |

| Field             | Bits | Type | Description  |
|-------------------|------|------|--|
| OUTn<br>(n = 7-0) | n    | r    | Output Status  0 Voltage level at channel n: $V_{\rm DS} > V_{\rm DS(OL)}$ . |
|                   |      |      | 1 Voltage level at channel n: $V_{\rm DS} < V_{\rm DS(OL)}$ .                |



Serial Peripheral Interface (SPI)

#### 4.4 Serial Peripheral Interface (SPI)

The diagnosis and control interface is based on a serial peripheral interface (SPI).

The SPI is <u>a full</u> duplex synchronous serial slave interface, which uses four lines: SO, SI, SCLK and  $\overline{\text{CS}}$ . Data is transferred by the lines SI and SO at the data rate given by SCLK. The falling edge of  $\overline{\text{CS}}$  indicates the beginning of a data access. Data is sampled in on line SI at the falling edge of SCLK and shifted out on line SO at the rising edge of SCLK. Each access must be terminated by a rising edge of  $\overline{\text{CS}}$ . A modulo 8 counter ensures that data is taken only, when a multiple of 8 bit has been transferred. The interface provides daisy chain capability.

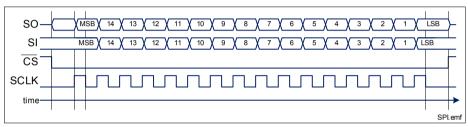


Figure 10 Serial Peripheral Interface

The SPI protocol is described in **Section 4.4.5**. It is reset to the default values after power-on reset or a low signal at pin RST.

# 4.4.1 SPI Signal Description

CS - Chip Select: The system micro controller selects the SPIDER - TLE7230G by means of the CS pin. Whenever the pin is in low state, data transfer can take place. When CS is in high state, any signals at the SCLK and SI pins are ignored and SO is forced into a high impedance state.

#### CS High to Low transition:

The diagnosis information is transferred into the shift register.

#### CS Low to High transition:

- Command decoding is only done, when after the falling edge of CS exactly a multiple (1, 2, 3, ...) of eight SCLK signals have been detected.
- Data from shift register is transferred into the input matrix register.
- · The diagnosis flags are cleared.

**SCLK - Serial Clock:** This input pin clocks the internal shift register. The serial input (SI) transfers data into the shift register on the falling edge of SCLK while the serial output

Data Sheet 25 V1.1, 2008-02-19



#### Serial Peripheral Interface (SPI)

(SO) shifts diagnostic information out on the rising edge of the serial clock. It is essential that the SCLK pin is in low state whenever chip select  $\overline{\text{CS}}$  makes any transition.

**SI - Serial Input:** Serial input data bits are shifted in at this pin, the most significant bit first. SI information is read on the falling edge of SCLK. The 16 bit input data consist of two parts (control and data). Please refer to **Section 4.4.5** for further information.

**SO Serial Output:** Data is shifted out serially at this pin, the most significant bit first. SO is in high impedance state until the  $\overline{CS}$  pin goes to low state. New data will appear at the SO pin following the rising edge of SCLK. Please refer to **Section 4.4.5** for further information.

#### 4.4.2 Daisy Chain Capability

The SPI of SPIDER - TLE7230G provides <u>daisy</u> cha<u>in</u> capability. In this configuration several devices are activated by the same CS signal MCS. The SI line of one device is connected with the SO line of another device (see **Figure 11**), which builds a chain. The ends of the chain are connected with the output and input of the master device, MO and MI respectively. The master device provides the master clock MCLK, which is connected to the SCLK line of each device in the chain.

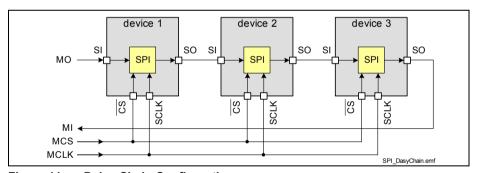


Figure 11 Daisy Chain Configuration

In the SPI block of each device, there is one shift register where one bit from SI line is shifted in each SCLK. The bit shifted out can be seen at SO. After 16 SCLK cyc<u>les</u>, the data transfer for one device has been finished. In single chip configuration, the  $\overline{\text{CS}}$  line must go high to make the device accept the transferred data. In daisy chain configuration the data shifted out at device #1 has been shifted in to device #2. When using three devices in daisy chain, three times 16 bits have to be shifted through the devices. After that, the  $\overline{\text{MCS}}$  line must go high (see **Figure 12**).

Data Sheet 26 V1.1, 2008-02-19



#### Serial Peripheral Interface (SPI)

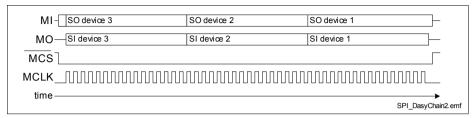


Figure 12 Data Transfer in Daisy Chain Configuration

# 4.4.3 Timing Diagrams

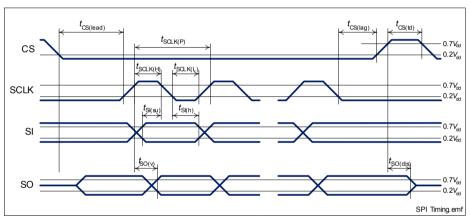


Figure 13 Timing Diagram

Data Sheet 27 V1.1, 2008-02-19



#### Serial Peripheral Interface (SPI)

#### 4.4.4 **Electrical Characteristics**

Unless otherwise specified:

 $V_{\rm VSO}$  = 3.0 V to 5.5 V,  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C typical values:  $V_{\rm VSO}$  = 5.0 V,  $V_{\rm dd}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.    | Parameter  | Symbol   | Lir        | nit Val | ues      | Unit | Test<br>Conditions  |  |
|---------|--|--|------------|---------|----------|------|---|--|
|         |  |  | min.       | typ.    | max.     |      |   |  |
| Power   | Supply   |  |            |         |          |      |   |  |
| 4.4.1   | Power supply voltage for SO buffer                     | $V_{ m VSO}$   | 3.0        |         | 5.5      | ٧    |   |  |
| Input ( | Characteristics (CS, S                                 | CLK, SI)   |            |         |          |      |   |  |
| 4.4.2   | L level of pin  CS  SCLK  SI                           | $V_{\mathrm{CS(L)}} \ V_{\mathrm{SCLK(L)}} \ V_{\mathrm{SI(L)}}$ | 0          |         | 1        | V    |   |  |
| 4.4.3   | H level of pin  CS  SCLK  SI                           | $V_{\mathrm{CS(H)}} \ V_{\mathrm{SCLK(H)}} \ V_{\mathrm{SI(H)}}$ | 2          |         | $V_{dd}$ | V    |   |  |
| 4.4.4   | L-input pull-up current through CS                     | $I_{\mathrm{CS(L)}}$   | 10         | 20      | 50       | μА   | V <sub>CS</sub> = 0 V   |  |
| 4.4.5   | H-input pull-up current through CS                     | $I_{\mathrm{CS(H)}}$   | 5          |         | 50       | μА   | 1) $V_{CS} = 2 \text{ V}$ 1)  |  |
| 4.4.6   | L-input pull-down<br>current through pin<br>SCLK<br>SI | $I_{\text{SCLK(L)}} \\ I_{\text{SI(L)}}$                         | 5          |         | 50       | μΑ   | $V_{\rm SCLK}$ = 1 V $V_{\rm Sl}$ = 1 V   |  |
| 4.4.7   | H-input pull-down<br>current through pin<br>SCLK<br>SI | $I_{\mathrm{SCLK(H)}}$ $I_{\mathrm{SI(H)}}$                      | 10         | 20      | 50       | μΑ   | $V_{\rm SCLK}$ = 5 V $V_{\rm SI}$ = 5 V   |  |
| Outpu   | t Characteristics (SO)                                 |  | •          | ,       |          | •    |   |  |
| 4.4.8   | L level output voltage                                 | $V_{\mathrm{SO(L)}}$   | 0          |         | 0.4      | V    | $I_{\rm SO}$ = -2.5 mA  |  |
| 4.4.9   | H level output voltage                                 | $V_{\rm SO(H)}$  | 4.6<br>2.4 |         | 5<br>3   |      | $I_{\rm SO} = 2 \text{ mA}$ $V_{\rm VSO} = 5 \text{ V}$ $V_{\rm VSO} = 3 \text{ V}$ |  |
| 4.4.10  | Output tristate leakage current                        | $I_{\rm SO(OFF)}$  | -10        |         | 10       | μА   | $V_{\rm CS} = V_{\rm dd}$   |  |



#### Serial Peripheral Interface (SPI)

Unless otherwise specified:

 $V_{\rm VSO}$  = 3.0 V to 5.5 V,  $V_{\rm dd}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C typical values:  $V_{\rm VSO}$  = 5.0 V,  $V_{\rm dd}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.   | Parameter  | Symbol                 | Lir  | nit Va | ues  | Unit | Test<br>Conditions                |  |
|--------|--|------------------------|------|--------|------|------|-----------------------------------|--|
|        |  |                        | min. | typ.   | max. |      |                                   |  |
| Timing | js   | I.                     |      | 1      |      |      |                                   |  |
| 4.4.11 | Serial clock frequency                                   | $f_{\sf SCLK}$         | 0    |        | 5    | MHz  |                                   |  |
| 4.4.12 | Serial clock period                                      | t <sub>SCLK(P)</sub>   | 200  |        |      | ns   |                                   |  |
| 4.4.13 | Serial clock high time                                   | t <sub>SCLK(H)</sub>   | 50   |        |      | ns   |                                   |  |
| 4.4.14 | Serial clock low time                                    | t <sub>SCLK(L)</sub>   | 50   |        |      | ns   |                                   |  |
| 4.4.15 | Enable lead time (falling CS to rising SCLK)             | $t_{ m SCLK(lead)}$    | 250  |        |      | ns   |                                   |  |
| 4.4.16 | Enable lag time (falling SCLK to rising CS)              | $t_{ m SCLK(lag)}$     | 250  |        |      | ns   |                                   |  |
| 4.4.17 | Transfer delay time (rising CS to falling CS)            | $t_{\mathrm{CS(del)}}$ | 250  |        |      | ns   |                                   |  |
| 4.4.18 | Data setup time<br>(required time SI to<br>falling SCLK) | $t_{\rm SI(su)}$       | 20   |        |      | ns   |                                   |  |
| 4.4.19 | Data hold time (falling SCLK to SI)                      | t <sub>SI(h)</sub>     | 20   |        |      | ns   |                                   |  |
| 4.4.20 | Output disable time (rising CS to SO tristate)           | $t_{SO(dis)}$          |      |        | 150  | ns   | 1)                                |  |
| 4.4.21 | Output data valid time with capacitive load              | $t_{\rm SO(v)}$        |      |        | 100  | ns   | $C_{\rm L}$ = 50 pF <sup>1)</sup> |  |

<sup>1)</sup> Not subject to production test, specified by design.



#### Serial Peripheral Interface (SPI)

Reset Value: xxxx<sub>H</sub>

#### 4.4.5 SPI Protocol

The SPI protocol of the SPIDER - TLE7230G provides two types of registers. The control registers and the diagnosis registers. After power-on reset, all register bits set to default values.

SI

| 15 | 14 | 13 | 12 | 11 | 10 | 9    | 8 | 7 | 6 | 5 | 4  | 3  | 2 | 1 | 0 |
|----|----|----|----|----|----|------|---|---|---|---|----|----|---|---|---|
| СМ | D  | 0  | 0  | 0  |    | ADDR |   |   |   |   | DA | TA | Ī | I | 1 |

| Field | Bits  | Type | Description  |
|-------|-------|------|--|
| CMD   | 15:14 |      | <ul> <li>Command</li> <li>Diagnosis only: The requested data is shifted out at SO. This command does not change any register setting.</li> <li>Read register: The register content of the addressed register will be sent in the next frame.</li> <li>Reset registers: All registers are reset to their default values.</li> <li>Write register: The data of the SI word will be written to the addressed register.</li> </ul> |
| ADDR  | 10:8  |      | Address Pointer to register for read and write command   |
| DATA  | 7:0   |      | Data Data written to or read from register selected by address ADDR  |



#### Serial Peripheral Interface (SPI)

# **SO Standard Diagnosis**

Reset Value: xxxx

|   | 15 | 14             | 13 | 12        | 11 | 10 | 9  | 8  | 7  | 6               | 5  | 4  | 3  | 2  | 1  | 0  |
|---|----|----------------|----|-----------|----|----|----|----|----|-----------------|----|----|----|----|----|----|
| Ī | CH | <del>1</del> 7 | CI | <b>H6</b> | CI | H5 | CI | H4 | Ci | <del>-</del> 13 | CI | H2 | CI | H1 | CI | Н0 |
| 1 | 1  |                |    | l         |    | 1  |    | 1  |    | 1               |    | 1  |    | 1  |    |    |

| Field            | Bits          | Type | Description  |  |  |  |  |  |  |
|------------------|---------------|------|--|--|--|--|--|--|--|
| CHn<br>(n = 7-0) | (2n+1):<br>2n |      | Standard Diagnosis for Channel n 00 Short circuit to GND 01 Open load 10 Over load, over temperature 11 Normal operation |  |  |  |  |  |  |

#### SO Second Frame of Read Command

Reset Value: xxxx<sub>H</sub>

| 1 | 5 | 14 | 13 | 12 | 11 | 10 | 9    | 8        | 7 | 6 | 5 | 4  | 3  | 2 | 1 | 0 |
|---|---|----|----|----|----|----|------|----------|---|---|---|----|----|---|---|---|
| ( | 0 | 1  | 0  | 0  | 0  |    | ADDR | <b>R</b> |   | I | I | DA | TA | 1 | 1 |   |

| Field | Bits | Type | Description   |
|-------|------|------|---|
| ADDR  | 10:8 |      | Address Pointer to register for read and write command              |
| DATA  | 7:0  |      | Data Data written to or read from register selected by address ADDR |

Note: Reading a register needs two SPI frames. In the first frame the RD command is sent. In the second frame the output at SPI signal SO will contain the requested information. A new command can be executed in the second frame.



# Serial Peripheral Interface (SPI)

# 4.4.6 Register Overview

| Name | W/R | Addr             | 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    | default         |
|------|-----|------------------|------|------|------|------|------|------|------|------|-----------------|
| IMCR | W/R | 001 <sub>B</sub> | MAP7 | MAP6 | MAP5 | MAP4 | MAP3 | MAP2 | MAP1 | MAP0 | 08 <sub>H</sub> |
| BOCR | W/R | 010 <sub>B</sub> | BOL7 | BOL6 | BOL5 | BOL4 | BOL3 | BOL2 | BOL1 | BOL0 | 00 <sub>H</sub> |
| OLCR | W/R | 011 <sub>B</sub> | OVL7 | OVL6 | OVL5 | OVL4 | OVL3 | OVL2 | OVL1 | OVL0 | 00 <sub>H</sub> |
| OTCR | W/R | 100 <sub>B</sub> | OVT7 | OVT6 | OVT5 | OVT4 | OVT3 | OVT2 | OVT1 | OVT0 | 00 <sub>H</sub> |
| SRCR | W/R | 101 <sub>B</sub> | SLE7 | SLE6 | SLE5 | SLE4 | SLE3 | SLE2 | SLE1 | SLE0 | 00 <sub>H</sub> |
| STA  | R   | 110 <sub>B</sub> | OUT7 | OUT6 | OUT5 | OUT4 | OUT3 | OUT2 | OUT1 | OUT0 | 00 <sub>H</sub> |
| CTL  | W/R | 111 <sub>B</sub> | OUT7 | OUT6 | OUT5 | OUT4 | OUT3 | OUT2 | OUT1 | OUT0 | 00 <sub>H</sub> |

<sup>1)</sup> The default values are set after reset.

**Package Outlines** 

# 5 Package Outlines

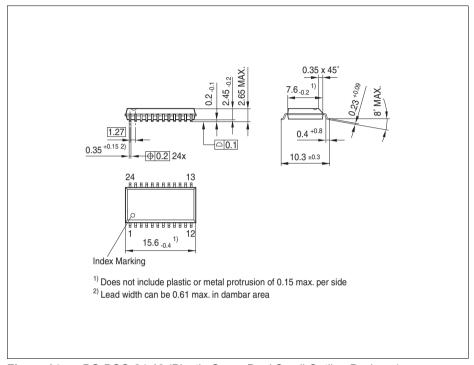


Figure 14 PG-DSO-24-13 (Plastic Green Dual Small Outline Package)

#### **Green Product (RoHS compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.

SMD = Surface Mounted Device

Dimensions in mm



**Revision History** 

# 6 Revision History

| Version | Date     | Changes   |
|---------|----------|---|
| V1.1    | 08-02-19 | Initial version of RoHS-compliant derivate of SPIDER - TLE7230G |
|         |          | Page 4: added AEC certified statement                           |
|         |          | Page 4 and 33: added RoHS compliance statement and              |
|         |          | Green product feature   |
|         |          | Page 3: updated package picture                                 |
|         |          | Page 3 and 33: Package changed to RoHS compliant version        |
|         |          | Page 35: updated Legal Disclaimer                               |



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